

# F7306-VB Datasheet Dual P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                    |                                    |                       |  |  |  |  |
|---------------------|------------------------------------|------------------------------------|-----------------------|--|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$    | I <sub>D</sub> (A) <sup>d, e</sup> | Q <sub>g</sub> (Typ.) |  |  |  |  |
| - 30                | 0.035 at V <sub>GS</sub> = - 10 V  | - 7.3                              | 17 nC                 |  |  |  |  |
| - 30                | 0.045 at V <sub>GS</sub> = - 4.5 V | - 6.3                              | 17110                 |  |  |  |  |

#### **FEATURES**

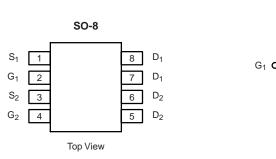
- · Halogen-free
- TrenchFET® Power MOSFET
- 100 % UIS Tested

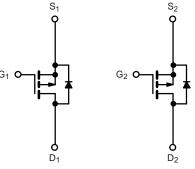


RoHS

#### **APPLICATIONS**

· Load Switches





P-Channel MOSFET

P-Channel MOSFET

| Parameter   | Symbol                            | Limit             | Unit                  |    |
|---|-----------------------------------|-------------------|-----------------------|----|
| Drain-Source Voltage                                | V <sub>DS</sub>                   | - 30              | V                     |    |
| Gate-Source Voltage                                 | $V_{GS}$                          | ± 20              | V                     |    |
|   | T <sub>C</sub> = 25 °C            |                   | - 7.3 <sup>e</sup>    |    |
| Continuous Drain Current (T <sub>.1</sub> = 150 °C) | T <sub>C</sub> = 70 °C            |                   | - 7.0 <sup>e</sup>    |    |
| Continuous Diam Curient (1) = 130 °C)               | T <sub>A</sub> = 25 °C            | I <sub>D</sub>    | - 7.3 <sup>a, b</sup> |    |
|   | T <sub>A</sub> = 70 °C            |                   | - 5.9 <sup>a, b</sup> | Λ  |
| Pulsed Drain Current                                | I <sub>DM</sub>                   | - 32 <sup>e</sup> | A                     |    |
| Continuous Course Danie Die de Courset              | T <sub>C</sub> = 25 °C            |                   | - 4.1                 |    |
| Continuous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C            | I <sub>S</sub>    | - 2.0 <sup>a, b</sup> |    |
| Avalanche Current                                   | 1 0.1 ml l                        | I <sub>AS</sub>   | - 20                  |    |
| Single-Pulse Avalanche Energy                       | L = 0.1 mH                        | E <sub>AS</sub>   | 20                    | mJ |
|   | T <sub>C</sub> = 25 °C            |                   | 5.0                   |    |
| Manianum Danian Disain ation                        | T <sub>C</sub> = 70 °C            | В                 | 3.2                   | w  |
| Maximum Power Dissipation                           | T <sub>A</sub> = 25 °C            | P <sub>D</sub>    | 2.5 <sup>a, b</sup>   | VV |
|   | T <sub>A</sub> = 70 °C            |                   | 1.6 <sup>a, b</sup>   |    |
| Operating Junction and Storage Temperature Rang     | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150       | °C                    |    |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |  |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |  |
| Maximum Junction-to-Ambient <sup>a, c</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 38      | 50      | °C/W |  |  |
| Maximum Junction-to-Foot                    | Steady State | $R_{thJF}$        | 20      | 25      | 1    |  |  |

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on  $T_C = 25 \, ^{\circ}C$ .
- e. Limited by package.



| Parameter                                     | Symbol   | Test Conditions  | Min.  | Тур.   | Max.  | Unit  |  |
|---|--|--|-------|--------|-------|-------|--|
| Static  | -  |  |       |        |       |       |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>  | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$   | - 30  |        |       | V     |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$  | In = - 250 µA  |       | - 31   |       | >//06 |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$  | I <sub>D</sub> = - 250 μA  |       | 4.5    |       | mV/°C |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$  | - 1.0 |        | - 3.0 | V     |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>   | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$  |       |        | ± 100 | nA    |  |
| Zana Cata Valtana Busin Comment               | 1  | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$   | 20 00 |        | - 1   |       |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>   | V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                    |       |        | - 5   | μΑ    |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>   | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$   | - 30  |        |       | Α     |  |
| Davis Course Co Otata Basista and             | _  | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 6.3 A   |       | 0.035  |       | 0     |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>  | V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 6.2 A  |       | 0.040  |       | Ω     |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>  | V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 6.1 A   |       | 23     |       | S     |  |
| Dynamic <sup>b</sup>                          |  |  |       |        |       |       |  |
| Input Capacitance                             | C <sub>iss</sub>   |  |       | 1350   |       | pF    |  |
| Output Capacitance                            | C <sub>oss</sub>   | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                          |       | 215    |       |       |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>   |  |       | 185    |       |       |  |
| Total Gate Charge                             | 0  | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -6.1 \text{ A}$                   |       | 32     | 50    |       |  |
|   | $Q_g = \frac{V_{DS} - 10 \text{ V}, V_{GS} - 10 \text{ V}, V_{D} - 0.17}{100000000000000000000000000000000000$ |  | 15    | 25     | 200   |       |  |
| Gate-Source Charge                            | $Q_{gs}$   | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6.1 \text{ A}$                  |       | 4      |       | nC    |  |
| Gate-Drain Charge                             | $Q_{gd}$   |  |       | 7.5    |       |       |  |
| Gate Resistance                               | $R_g$  | f = 1 MHz  |       | 5.8    |       | Ω     |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>   |  |       | 10     | 15    |       |  |
| Rise Time                                     | t <sub>r</sub>   | $V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$  |       | 8      | 15    |       |  |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>  | $I_D \cong$ - 1 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$                                  |       | 45     | 70    |       |  |
| Fall Time                                     | t <sub>f</sub>   |  |       | 12     | 25    | 20    |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>   |  |       | 42     | 70    | ns    |  |
| Rise Time                                     | t <sub>r</sub>   | $V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$   |       | 35     | 60    |       |  |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>  | $I_D \cong$ - 1 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$                                 |       | 40     | 70    |       |  |
| Fall Time                                     | t <sub>f</sub>   | ]  |       | 16     | 30    |       |  |
| <b>Drain-Source Body Diode Characterist</b>   | ics  |  |       |        | •     |       |  |
| Continous Source-Drain Diode Current          | I <sub>S</sub>   | T <sub>C</sub> = 25 °C   |       |        | - 4.1 | ۸     |  |
| Pulse Diode Forward Current                   | I <sub>SM</sub>  |  |       |        | - 32  | Α     |  |
| Body Diode Voltage                            | V <sub>SD</sub>  | I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V  |       | - 0.75 | - 1.2 | V     |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>  |  |       | 34     | 60    | ns    |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>  | 1 2 A d1/d+ 100 A/va T 25 °C   |       | 22     | 40    | nC    |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>   | $I_F = -2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ |       | 11     |       | 1     |  |
| Reverse Recovery Rise Time                    |  | t <sub>b</sub>   |       | 23     | İ     | ns    |  |

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

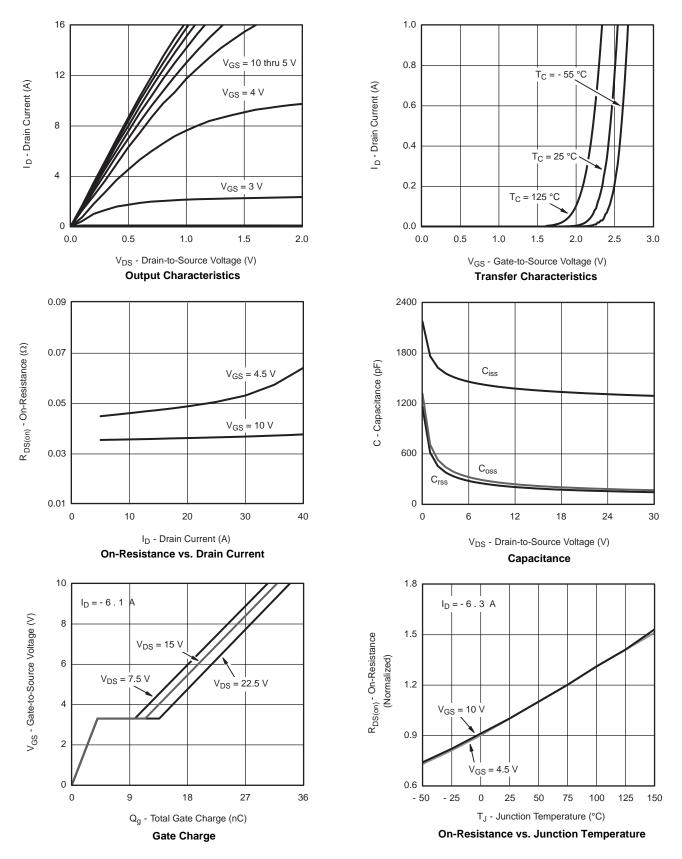
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a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

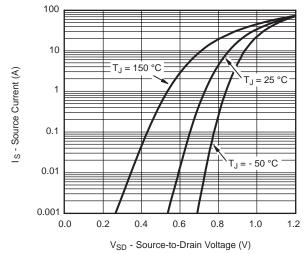


#### TYPICAL CHARACTERISTICS 25 C, unless otherwise noted

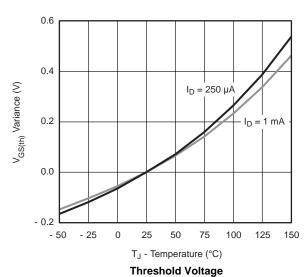




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

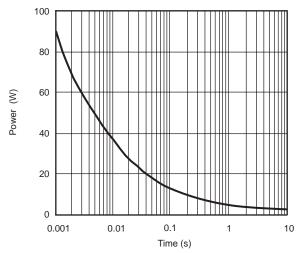


#### Source-Drain Diode Forward Voltage

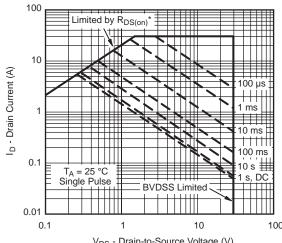


0.10 I<sub>D</sub> = -6.3 A 0.08  $R_{DS(on)}$  - On-Resistance ( $\Omega$ ) 0.06 T<sub>J</sub> = 125 °C 0.04 0.02 T<sub>J</sub> = 25 °C 0.00 0 2 6 8 10 V<sub>GS</sub> - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



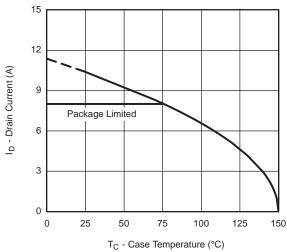
V<sub>DS</sub> - Drain-to-Source Voltage (V)

Safe Operating Area

<sup>\*</sup>  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

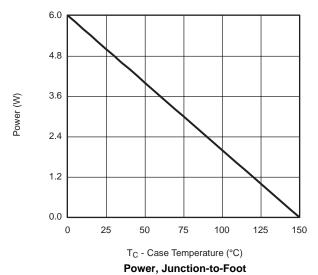


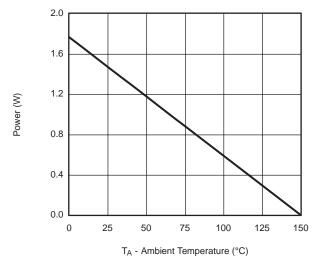
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





#### Current Derating\*



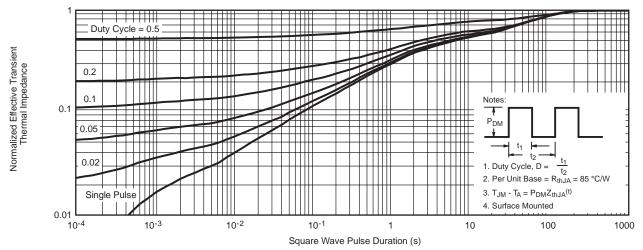


Power Derating, Junction-to-Ambient

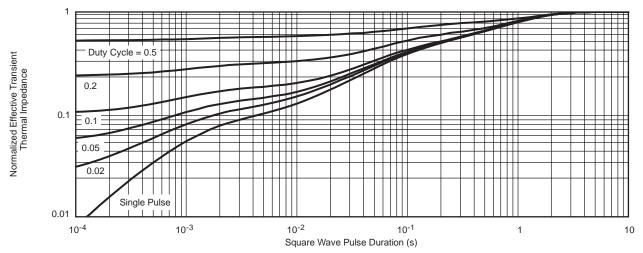
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

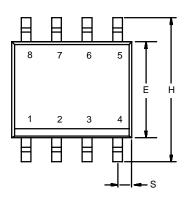


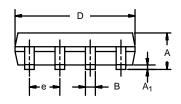
Normalized Thermal Transient Impedance, Junction-to-Foot

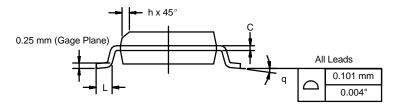
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**SOIC (NARROW): 8-LEAD**JEDEC Part Number: MS-012







|                              | MILLIM | IETERS | INC       | HES   |  |  |
|------------------------------|--------|--------|-----------|-------|--|--|
| DIM                          | Min    | Max    | Min       | Max   |  |  |
| Α                            | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>               | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                            | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                            | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                            | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| E                            | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                            | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                            | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                            | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                            | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                            | 0°     | 8°     | 0°        | 8°    |  |  |
| S                            | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| FCN: C-06527-Rev I 11-Sen-06 |        |        |           |       |  |  |

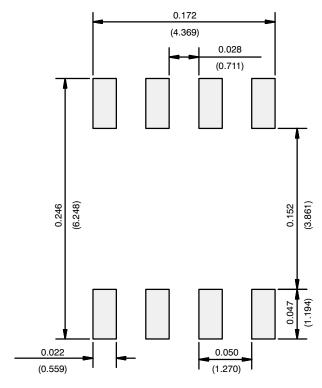
ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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